International Rectifier

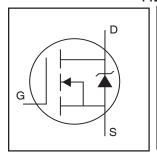
AUTOMOTIVE GRADE

AUIRF2807

HEXFET® Power MOSFET

Features

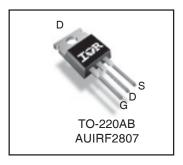
- Advanced Planar Technology
- Low On-Resistance
- Dynamic dV/dT Rating
- 175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated
- Repetitive Avalanche Allowed up to Tjmax
- Lead-Free, RoHS Compliant
- Automotive Qualified *



V _{(BR)DSS}	75V
R _{DS(on)} max.	13m Ω
I _{D(Silicon Limited)}	82A®
I _{D (Package Limited)}	75A

Description

Specifically designed for Automotive applications, this Stripe Planar design of HEXFET® Power MOSFETs utilizes the latest processing techniques to achieve low on-resistance per silicon area. This benefit combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in Automotive and a wide variety of other applications.



G	D	S
Gate	Drain	Source

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	82©	
$I_D @ T_C = 100^{\circ}C$	Continuous Drain Current, V _{GS} @ 10V (Silicon Limited)	58	Α
I _D @ T _C = 25°C	Continuous Drain Current, V _{GS} @ 10V (Package Limited)	75	
I _{DM}	Pulsed Drain Current ①	280	
P _D @T _C = 25°C	Power Dissipation	230	W
	Linear Derating Factor	1.5	W/°C
V_{GS}	Gate-to-Source Voltage	±20	V
E _{AS}	Single Pulse Avalanche Energy ②⑤	340	mJ
I _{AR}	Avalanche Current ①	43	Α
E _{AR}	Repetitive Avalanche Energy ①	23	mJ
dv/dt	Peak Diode Recovery dv/dt ③	5.9	V/ns
T_J	Operating Junction and	-55 to + 175	
T _{STG}	Storage Temperature Range	-93 10 + 173	°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1N•m)	

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case		0.65	
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.50		°C/W
$R_{\theta,JA}$	Junction-to-Ambient		62	

HEXFET® is a registered trademark of International Rectifier.

^{*}Qualification standards can be found at http://www.irf.com/



Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
$V_{(BR)DSS}$	Drain-to-Source Breakdown Voltage	75			V	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.074		V/°C	Reference to 25°C, I _D = 1mA
R _{DS(on)}	Static Drain-to-Source On-Resistance			13	mΩ	V _{GS} = 10V, I _D = 43A ⊕
$V_{GS(th)}$	Gate Threshold Voltage	2.0		4.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
gfs	Forward Transconductance	38			S	V _{DS} = 50V, I _D = 43A⊕
I _{DSS}	Drain-to-Source Leakage Current			25	μΑ	$V_{DS} = 75V$, $V_{GS} = 0V$
				250		$V_{DS} = 60V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = 20V$
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -20V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

bynamic Electrical Characteristics & 1j = 25 0 (unless otherwise specified)									
Q_g	Total Gate Charge			160		I _D = 43A			
Q_{gs}	Gate-to-Source Charge			29	nC	$V_{DS} = 60V$			
Q_{gd}	Gate-to-Drain ("Miller") Charge			55		V _{GS} = 10V, See Fig.6 and 13 ⊕			
t _{d(on)}	Turn-On Delay Time		13			$V_{DD} = 38V$			
t _r	Rise Time		64			$I_D = 43A$			
t _{d(off)}	Turn-Off Delay Time		49		ns	$R_G = 2.5\Omega$			
t _f	Fall Time		48			V _{GS} = 10V,, See Fig.10 ⊕			
L _D	Internal Drain Inductance		4.5		nH	Between lead, 6mm (0.25in.)			
L _S	Internal Source Inductance		7.5			Between lead, and center of die contact			
C _{iss}	Input Capacitance		3820			V _{GS} = 0V			
Coss	Output Capacitance		610		pF	$V_{DS} = 25V$			
C _{rss}	Reverse Transfer Capacitance		130		[f = 1.0MHz, See Fig.5			

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions	
I _S	Continuous Source Current			82©		MOSFET symbol	
	(Body Diode)		820		Α	showing the	
I _{SM}	Pulsed Source Current			280		integral reverse	
	(Body Diode) ①			200		p-n junction diode.	
V_{SD}	Diode Forward Voltage			1.2	V	T _J = 25°C, I _S = 43A, V _{GS} = 0V ⊕	
t _{rr}	Reverse Recovery Time		100	150	ns	$T_J = 25^{\circ}C, I_F = 43A$	
Q _{rr}	Reverse Recovery Charge		410	610	nC	di/dt = 100A/µs ④	
t _{on}	Forward Turn-On Time	Intrinsic	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- ② Starting $T_J = 25$ °C, $L = 370\mu H$, $R_G = 25\Omega$, $I_{AS} = 43A$, $V_{GS} = 10V$ (See Figure 12)
- 4 Pulse width \leq 400 μ s; duty cycle \leq 2%.
- 6 Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 75A.

Qualification Information[†]

		Automotive (per AEC-Q101) ††					
Qualification	n Level	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.					
Moisture Se	nsitivity Level	3L-TO-220	N/A				
	Machine Model		Class M4(+/- 800V) ^{†††} (per AEC-Q101-002)				
Human Body Model Charged Device Model		Class H1C(+/- 2000V) ^{†††} (per AEC-Q101-001)					
		Class C5(+/- 2000V) ^{†††} (per AEC-Q101-005)					
RoHS Comp	liant	Yes					

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

^{††} Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

^{†††} Highest passing voltage

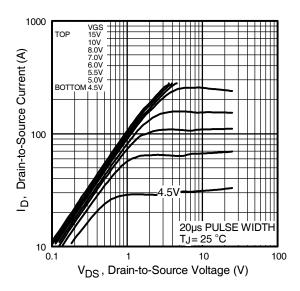


Fig 1. Typical Output Characteristics

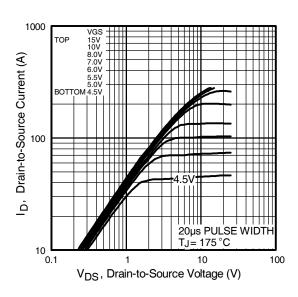


Fig 2. Typical Output Characteristics

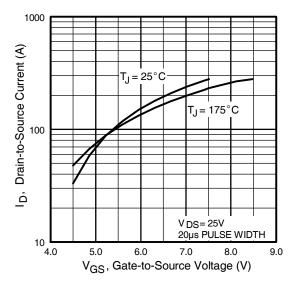


Fig 3. Typical Transfer Characteristics

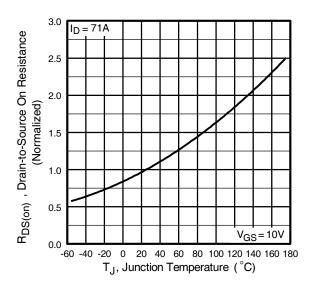


Fig 4. Normalized On-Resistance Vs. Temperature

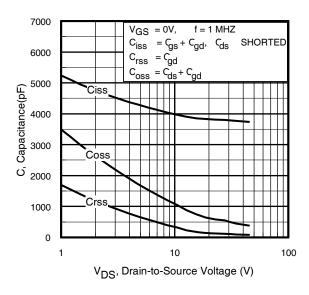


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

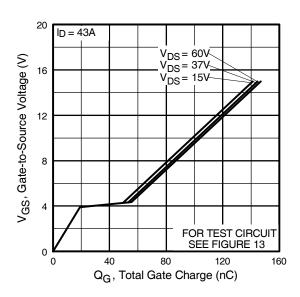


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

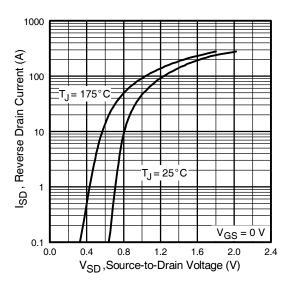


Fig 7. Typical Source-Drain Diode Forward Voltage

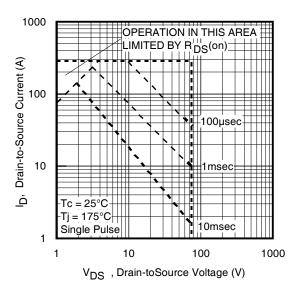


Fig 8. Maximum Safe Operating Area

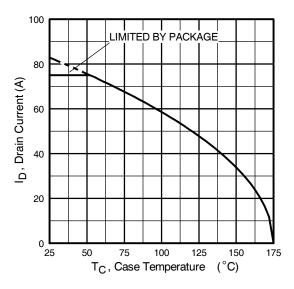


Fig 9. Maximum Drain Current Vs. Case Temperature

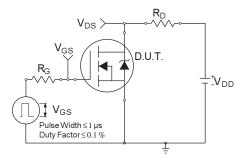


Fig 10a. Switching Time Test Circuit

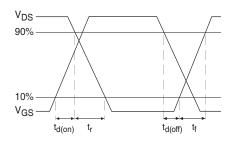


Fig 10b. Switching Time Waveforms

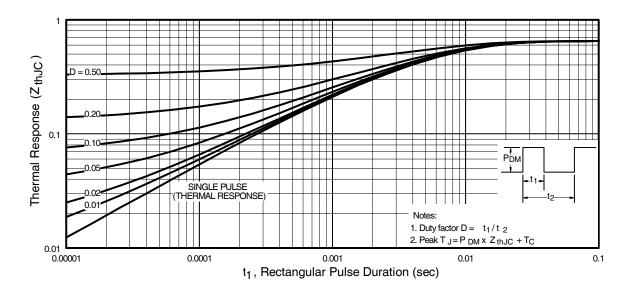


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

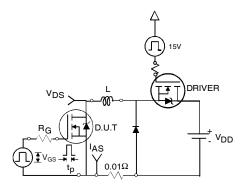


Fig 12a. Unclamped Inductive Test Circuit

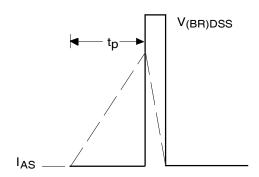


Fig 12b. Unclamped Inductive Waveforms

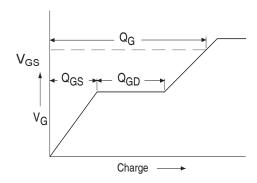


Fig 13a. Basic Gate Charge Waveform

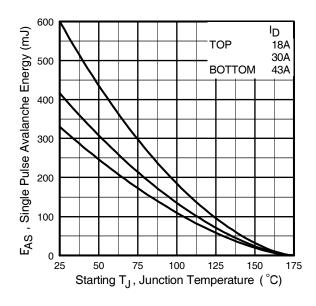


Fig 12c. Maximum Avalanche Energy Vs. Drain Current

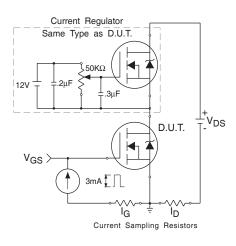
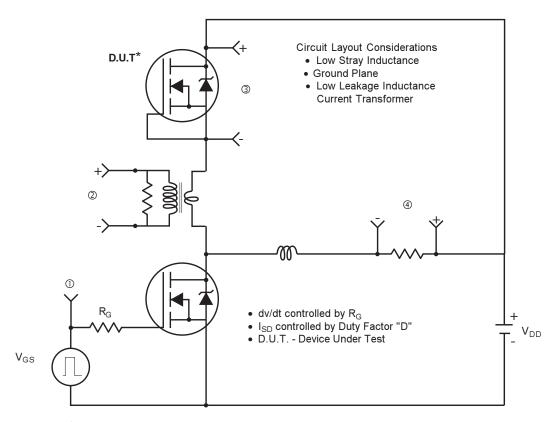
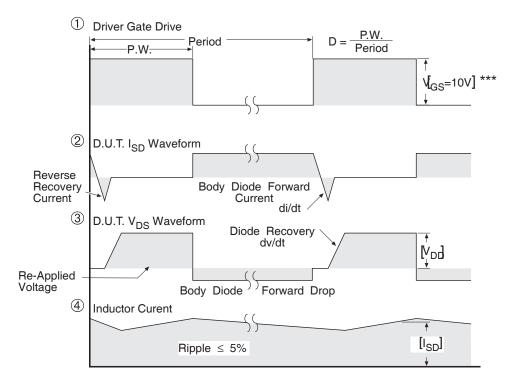


Fig 13b. Gate Charge Test Circuit

Peak Diode Recovery dv/dt Test Circuit



^{*} Reverse Polarity of D.U.T for P-Channel

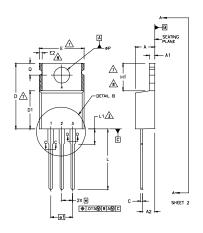


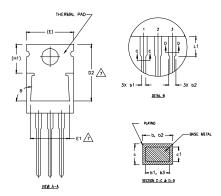
*** V_{GS} = 5.0V for Logic Level and 3V Drive Devices

Fig 14. For N-channel HEXFET® power MOSFETs

TO-220AB Package Outline

Dimensions are shown in millimeters (inches)





NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5 M- 1994. DIMENSIONS ARE SHOWN IN INCHES [MILLIMETERS]. LEAD DIMENSION AND FINISH UNCONTROLLED IN L1.
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH, MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- DIMENSION 61 & c1 APPLY TO BASE METAL ONLY. CONTROLLING DIMENSION : INCHES.

MIN.

3.56

0.51

2.04

0.38

0.38

1.15

1.15

0.36

0.36

14.22

8.38

12.19

9.66

8.38

12,70

3.54

2,54

SYMBOL

Α1

Α2

b

b1

b2

b3

C

c1

D

D1

D2

Ε

E1

e e1 Н1

L1

φP

Q

THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS E,H1,D2 & E1

MAX.

4.82

1.40

2.92

1.01

0.96

1.77

1.73

0.61

0.56

16.51

9.02

12,88

10,66

8.89

14,73

6.35

4.08

DIMENSIONS

INCHES

MAX.

.190

.055 ,115

N4N

.038

.070

.068

.024

.022

.650

.355

.507

.420

.350

.580

.250

.161

.135

MIN.

.140

.020

.080

015

.015

.045

.045

.014

.014

560

.330

.480

.380

.330

.500

.139

.100

NOTES

5

5

4

4,7

3

5	DIMEN	SIUN	LZ X	н	DEFINE	A ZUI	NE W	HERE	STAMI
	AND	SING	JLATIC	N IF	RREGULA	RITIES	ARE	ALLO	₩ED.

MILLIMETERS

LEAD ASSIGNMENTS

HEXFET

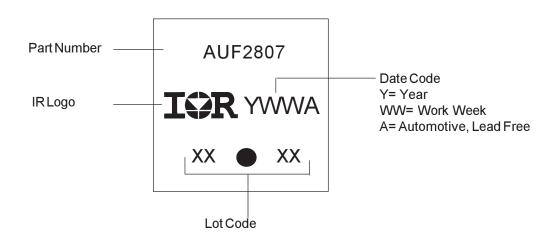
IGBTs, CoPACK

1.- GATE 2.- COLLECTOR 3.- EMITTER

DIODES

1.- ANODE/OPEN 2.- CATHODE 3.- ANODE

TO-220AB Part Marking Information



AUIRF2807

Ordering Information

Base part	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRF2807	TO-220	Tube	50	AUIRF2807

AUIRF2807

IMPORTANTNOTICE

Unless specifically designated for the automotive market, International Rectifier Corporation and its subsidiaries (IR) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or services without notice. Part numbers designated with the "AU" prefix follow automotive industry and / or customer specific requirements with regards to product discontinuance and process change notification. All products are sold subject to IR's terms and conditions of sale supplied at the time of order acknowledgment.

IR warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with IR's standard warranty. Testing and other quality control techniques are used to the extent IR deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

IR assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using IR components. To minimize the risks with customer products and applications, customers should provide adequate design and operating safeguards.

Reproduction of IR information in IR data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alterations is an unfair and deceptive business practice. IR is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of IR products or serviced with statements different from or beyond the parameters stated by IR for that product or service voids all express and any implied warranties for the associated IR product or service and is an unfair and deceptive business practice. IR is not responsible or liable for any such statements.

IR products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or in any other application in which the failure of the IR product could create a situation where personal injury or death may occur. Should Buyer purchase or use IR products for any such unintended or unauthorized application, Buyer shall indemnify and hold International Rectifier and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that IR was negligent regarding the design or manufacture of the product.

Only products certified as military grade by the Defense Logistics Agency (DLA) of the US Department of Defense, are designed and manufactured to meet DLA military specifications required by certain military, aerospace or other applications. Buyers acknowledge and agree that any use of IR products not certified by DLA as military-grade, in applications requiring military grade products, is solely at the Buyer's own risk and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

IR products are neither designed nor intended for use in automotive applications or environments unless the specific IR products are designated by IR as compliant with ISO/TS 16949 requirements and bear a part number including the designation "AU". Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, IR will not be responsible for any failure to meet such requirements.

For technical support, please contact IR's Technical Assistance Center http://www.irf.com/technical-info/

WORLDHEADQUARTERS:

101 N. Sepulveda Blvd., El Segundo, California 90245 Tel: (310) 252-7105

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

International Rectifier:

AUIRF2807